













Comment	Description	Designator 1V2, 1V8, 3V3, 5V, 16V, DCLK, DE, DINT, DISP,	Footprint	LibRef	Quantity
TP		DRST, EECLK, EECS, EEDATA, GND, HSYNC, I2C_SCL, I2C_SDA, TCK, TDI, TDO, TMS, VSYNC	TP_0.75DIA	TP	22
C0402C104K4RACTU	CAP CER 0.1UF 16V X7R 0402	C1, C2, C7, C8, C9, C10, C12, C14, C15, C16, C17, C18, C19, C20, C21, C22, C23, C24, C25, C26, C27, C28, C29, C30, C31, C32	CAD 0403 ic	C0402C104K4RAC-TU	26
C0402C104K4RACTU C0402C180K3GACTU	CAP CER 18PF 25V NPO 0402	C3, C4	CAP_0402_imperial CAP_0402_imperial	C0402C104K4RAC-1U C0402C180K3GACTU	26
CAP 3.3uF 10V 0603(1608)	CAP CER 3.3UF 6.3V X5R 0603	C5	CAP_0603_imperial	C0603C335M9PACTU	1
C0402C104K4RAC-TU	CAP CER 0.1UF 16V X7R 0402	C6, C41	CAP_0402_imperial	C0402C104K4RAC-TU	2
	4.7μF ±10% 25V X5R Ceramic Capacitor - 55°C ~ 85°C Surface Mount, MLCC 0603 (1608 Metric) 0.063° L x				
CAP 4.7uF 10V 0805(2012)	0.031" W (1.60mm x 0.80mm)	C11, C13	CAP_0603_imperial	GRM188R61E475KE11D	2
06035A220JAT2A	CAP CER 22PF 50V COG 0603 CAP CER 10UF 10V X5R	C33, C36	CAP_0603_imperial	C1608C0G1H220J080AA	2
GRM31CR61E106KA12L	0603 CAP CER 2.2UF 10V X7R	C34, C35, C37, C38, C39	CAP_0603_imperial	LMK107BJ106MALTD	5
GRM188R61A225KE34x	0603 Schottky Barrier Diode	C40	CAP_0603_imperial	GRM188R71A225KE15D	1
NSR05F40NXT5G	2-Pin DSN, Pb-Free, Tape and Reel	D1	ONSC-DSN-2-152AC- 01_V	CMP-1055-00232-1	1
	LED, SMT, 0603(1608), 0.25mm Tthickness,	DS1, DS2, DS3, DS4,	KING-LED0603-25-		
APG1608SEKC/T	Super Bright Orange LED, SMT, 0603(1608), 0.25mm Thickness,	DS5, DS6, DS7, DS8	ORANGE_V KING-LED0603-25-	CMP-0239-00002-1	8
APG1608CGKC/T	Green Chip Ferrite Bead for	DS9	GREEN_V	CMP-0239-00001-1	1
BLM18AG601SN1D	General Use, 600 Ohm, 500 mA, -55 to 125 degC, 1.6 x 0.8 x 0.95 mm SMD, Tape and Reel	FB1, FB2, FB3, FB4, FB5	MURA-BLM18-F-H1- CHIP-2_V	CMP-0686-00436-2	5
	Micro-USB B Receptacle, Right				
105017-0001	Angle, Bottom Mount, Surface Mount, with Solder Tabs, -30 to 85 degC, 5-Pin USB, RoHS, Tape and Reel	113	USB-MICRO-B_V	CMP-2000-05827-1	1
AYF534035	CONN FFC FPC 40POS 0.50MM R/A	J2	AYF534035	AYF534035	1
AYF530635	CONN FFC FPC 6POS 0.50MM R/A	J3	AYF530635	AYF530635	1
	Pin header 12P, 610112249121, Würth				
610112249121	Elektronik Semi-shielded Power Inductor, 2.2 uH, +/- 20%, 1.8 A, -40 to 125 degC, 3 x 3 x 1.5 mm	J4	610112249121	610112249121	1
SRN3015-2R2M	SMD, RoHS and Halogen Free, Tape and Reel Chip Inductor	L1, L2	BOUR-SRN3015-2_V	CMP-0007-00003-1	2
	, 10 uH, +/- 10%, -40 to 125 degC, 1210 (3225 Metric), RoHS, Tape				
CM322522-100KL	and Reel RES SMD 5.1K OHM 1%	L3	BOUR-CM322522_V	CMP-1747-00008-1	1
5K1 1% 0402(1005)	1/16W 0402 YAGEO (PHYCOMP) RC0402FR-072K2L SMD Chip Resistor, Thick Film, 2.2 kohm, 50 V, 0402 [1005 Metric].	R1, R2, R3	RES_0402_imperial  RES_0402_imperial	RC0402FR-075K1L	3
2K2 1% 0402(1005) RC0402FR-0712KL	63 mW, 1% RES SMD 12K OHM 1% 1/16W 0402	R4, R5, R6 R7	RES_0402_imperial	RC0402FR-072K2L RC0402FR-0712KL	3
390R 1% 2512(6432)	PANASONIC ELECTRONIC COMPONENTS ERA3AEB391V SMD Chip Resistor, Thin Film, 390 ohm, 75 V, 0603 [1608 Metric], 100 mW, 0.1%, ERA Series	R8	RES_0603_imperial	ERA3AEB391V	1
_	Res Thin Film 0603 220 Ohm 0.1% 1/10W ±25ppm/C Molded				
220R 1% 0603(1608)	SMD Punched Carrier T/R Res Thin Film 0603 4.7K	R9, R10, R11, R12, R13, R14, R15, R16, R19	RES_0603_imperial	ERA-3AEB221V	9
	Ohm 0.1% 0.1W(1/10W) ±25ppm/C Molded SMD Automotive				
4K7 1% 0603(1608)	Punched T/R RESISTOR, 0603, 0.1W,	R17, R18, R26	RES_0603_imperial	ERA-3AEB472V	3
820K 1% 0603(1608)	1%, 820K RESISTOR, 0603, 180K,	R20, R21	RES_0603_imperial	ERJ-3EKF8203V ERA-3AFR184V	2
180K 1% 0603(1608)	0.1%, 0.1W PANASONIC ELECTRONIC COMPONENTS ERJ3EKF5602V. SMD Chip Resistor, Thick Film, 56 kohm, 75 V, 0603 [1608 Metric], 100 mW, 1%, EPJ3E	R22, R23, R24	RES_0603_imperial	ERA-JAEB184V	3
56K 1% 0603(1608)	100 mW, 1%, ERJ3E Series	R25	RES_0603_imperial	ERJ-3EKF5602V	1
LCMXO2-7000HE-	MachXO2 High Performance CPLD with 6864 LUTs, 1.2V, 144- pin TOFP, Speed Grade-				
LCMXO2-7000HE- 4TG144C	4, Commercial Grade, Halogen Free (RoHS) Dual High Speed USB to Multipurpose UART / FIFO IC	U1	TQFP144_L	CMP-0111-00327-1	1
FT2232HL	, 3 to 3.6 V, -40 to 85 degC, 64- Pin LQFP, RoHS	U2	FTDI-LQFP-64_L	CMP-2000-06287-1	
93LCS56-XSN	Imported Buck Step Down Regulator with 2.3 to 6 V Input and 0.6 to 6 V Output40 to 85	U3	SOIC8-N_MC	93LCS56-XSN	1
TPS62290DRVR	degC, 6-Pin SON (DRV), Green (RoHS & no Sh/Rr)	HA 115	DDV6-1600Y1000TD	CMP-0323-00361-1	
IPS62290DRVR MIC2288YD5	Sb/Br) Imported	U4, U5 U6	DRV6-1600X1000TP TSOT-23-5_D5	MIC2288YD5	1
	12MHz ±30ppm Crystal 18pF 100 Ohm -20°C ~ 70°C Surface Mount 4-				
7M-12.000MAAJ-T	SMD, No Lead (DFN, LCC)	X1	7M-12.000MAAJ-T	7M-12.000MAAJ-T	1

## **Design Rules Verification Report**

Filename : C:\Users\fred\\Documents\Hardware\Projects\LCD-Controller\LCD-Controller.PcbDoc

Warnings 0 Rule Violations 0 Waived Violations 11

## Warnings Total 0

Rule Violations			
Clearance Constraint (Gap=0.13mm) (All),(All)			
Short-Circuit Constraint (Allowed=No) (All),(All)			
Un-Routed Net Constraint ( (All) )	0		
Modified Polygon (Allow modified: No), (Allow shelved: No)	0		
Width Constraint (Min=0.15mm) (Max=1mm) (Preferred=0.254mm) (All)	0		
Width Constraint (Min=0.25mm) (Max=1.5mm) (Preferred=1mm) (InNetClass('Power'))	0		
Power Plane Connect Rule(Relief Connect )(Expansion=0.508mm) (Conductor Width=0.254mm) (Air Gap=0.254mm)	0		
Hole Size Constraint (Min=0.025mm) (Max=2.54mm) (All)	0		
Hole To Hole Clearance (Gap=0.254mm) (All),(All)	0		
Minimum Solder Mask Sliver (Gap=0mm) (All),(All)	0		
Silk To Solder Mask (Clearance=0mm) (IsPad),(All)	0		
Silk to Silk (Clearance=0mm) (AII),(AII)	0		
Net Antennae (Tolerance=0.1mm) (All)	0		
Board Clearance Constraint (Gap=0mm) (All)	0		
Height Constraint (Min=0mm) (Max=25.4mm) (Prefered=12.7mm) (All)			
Total	0		

Waived Violations	
Board Clearance Constraint (Gap=0mm) (All)	11
Total	11

## Board Clearance Constraint (Gap=0mm) (All)

Board Outline Clearance(Outline Edge): (0mm < 0.15mm) Between Board Edge And Text "DINT" (53.7mm,0.15mm) on Top Overlay Waived by Board Outline Clearance(Outline Edge): (0mm < 0.15mm) Between Board Edge And Text "DRST" (55.9mm,0.15mm) on Top Overlay Waived by Board Outline Clearance(Outline Edge): (0.09mm < 0.15mm) Between Board Edge And Track (108.1mm,0.19mm)(108.1mm,15.43mm) on Top Board Outline Clearance(Outline Edge): (Collision < 0.15mm) Between Board Edge And Track (113.588mm,24.855mm)(114.4mm,24.855mm) on Top Board Outline Clearance(Outline Edge): (Collision < 0.15mm) Between Board Edge And Track (113.588mm,32.345mm)(114.4mm,32.345mm) on Top Board Outline Clearance(Outline Edge): (Collision < 0.15mm) Between Board Edge And Track (114.4mm,24.855mm)(114.4mm,32.345mm) on Top Board Outline Clearance(Outline Edge): (0.103mm < 0.15mm) Between Board Edge And Track (91.2mm,0.23mm)(91.2mm,7.7mm) on Top Overlay Board Outline Clearance(Outline Edge): (0.103mm < 0.15mm) Between Board Edge And Track (94.3mm,0.23mm)(96.9mm,0.23mm) on Top Overlay Board Outline Clearance(Outline Edge): (0.09mm < 0.15mm) Between Board Edge And Track (96.9mm,0.19mm)(108.1mm,0.19mm) on Top Overlay Board Outline Clearance(Outline Edge): (0.09mm < 0.15mm) Between Board Edge And Track (96.9mm,0.19mm)(108.1mm,0.19mm) on Top Overlay Board Outline Clearance(Outline Edge): (0.09mm < 0.15mm) Between Board Edge And Track (96.9mm,0.19mm)(108.1mm,0.19mm) on Top Overlay Board Outline Clearance(Outline Edge): (0.09mm < 0.15mm) Between Board Edge And Track (96.9mm,0.19mm)(108.1mm,0.19mm) on Top Overlay Board Outline Edge): (0.09mm < 0.15mm) Between Board Edge And Track (96.9mm,0.19mm)(108.1mm,0.19mm) on Top Overlay Board Outline Edge): (0.09mm < 0.15mm) Between Board Edge And Track (96.9mm,0.19mm)(108.1mm,0.19mm) on Top Overlay Board Outline Edge): (0.09mm < 0.15mm) Between Board Edge And Track (96.9mm,0.19mm)(108.1mm,0.19mm) on Top Overlay Board Outline Edge): (0.09mm < 0.15mm) Between Board Edge And Track (96.9mm,0.19mm)(108.1mm,0.19mm) on Top Overlay

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